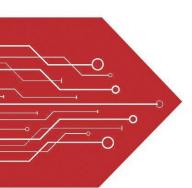
# MSKSEMI















**ESD** 

TVS

**TSS** 

MOV

**GDT** 

**PLED** 

Broduct data speet



- Solid-state silicon-avalanche technology
- Low operating and clamping voltage
- Up to four I/O Lines of Protection
- Ultra low capacitance: 0.3pF typical(I/O to I/O)
- Low Leakage
- Low operating voltage:5V
- Flow-Through design

## IEC COMPATIBILITY (EN61000-4)

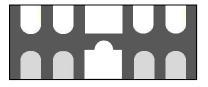
- IEC 61000-4-2 (ESD) ±15kV (air), ±8kV (contact)
- IEC 61000-4-4 (EFT) 40A (5/50ns)
- IEC 61000-4-5 (Lightning) 5A (8/20μs)

#### **Mechanical Characteristics**

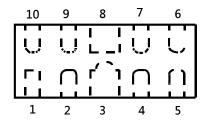
- Molding compound flammability rating: UL 94V-0
- Marking: Marking Code
- Packaging: Tape and Reel
- RoHS/WEEE Compliant

## **Applications**

- Digital Visual Interface(DVI)
- MDDI Ports
- DisplayPortTM Interface
- PCI Express
- High Definition Multi-Media Interface(HDMI)
- eSATA Interfaces



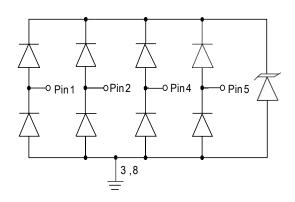
uSON-10



## **Schematic & PIN Configuration**

Pin	Identificaion
1,2,4,5	Input Lines
6,7,9,10	Output Lines (No Internal Connection)
3,8	Ground

## **Circuit Diagram**



4-Line Protection

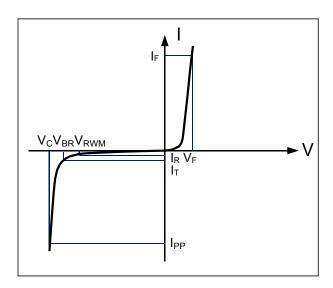




Rating	Symbol	Value	Units
Peak Pulse Power ( t <sub>p</sub> =8/20μs )	P <sub>PP</sub>	75	Watts
Peak Pulse Current ( t <sub>p</sub> =8/20μs )	I <sub>pp</sub>	5	А
ESD per IEC 61000-4-2(Air) ESD per IEC 61000-4-2(contact)	V <sub>ESD</sub>	+/-17 +/-12	kV
Operating Temperature	TJ	-55 to + 125	°C
Storage Temperature	T <sub>STG</sub>	-55 to +150	°C

## Electrical Parameters (T=25°C)

Symbol	Parameter
<b>I</b> PP	Maximum Reverse Peak Pulse Current
Vc	Clamping Voltage @ IPP
VRWM	Working Peak Reverse Voltage
lr	Maximum Reverse Leakage Current @ VRWM
V <sub>BR</sub>	Breakdown Voltage @ I⊤
lτ	Test Current
le	Forward Current
VF	Forward Voltage @ I <sub>F</sub>

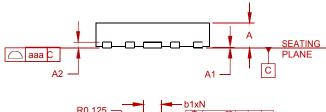


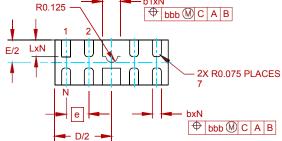
## **Electrical Characteristics**

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Units
Reverse Stand-Off Voltage	V <sub>RWM</sub>	Any I/O pin to ground			5V	V
Reverse Breakdown Voltage	$V_{BR}$	I <sub>t</sub> = 1mA Any I/O pin to ground	6.0			V
Reverse Leakage Current	I <sub>R</sub>	V <sub>RWM</sub> = 5V, T=25°C Any I/O pin to ground			1	μA
Clamping Voltage	Vc	I <sub>pp</sub> =5A, t <sub>p</sub> =8/20μs Any I/O pin to ground			15	V
		V <sub>R</sub> = 0V, f = 1MHz I/O pin to GND			0.8	pF
Junction Capacitance	C <sub>j</sub>	V <sub>R</sub> = 0V, f = 1MHz Between I/O pins		0.3		pF

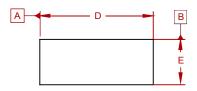


#### **PACKAGE MECHANICAL DATA**



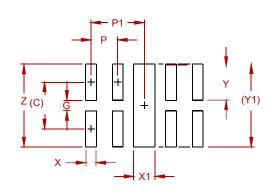


Dimensions in millimeters



DIMENSI ONS						
DIM	DIM INCHES		MILLIMETERS			
	MIN	NOM	MAX	MIN	NOM	MAX
Α	.020	.023	.026	0.50	0.58	0.65
A1	0.00	.001	.002	0.00	0.03	0.05
A2	(.005)		(0	).13)		
b	.006	.008	.010	0.15	0.20	0.25
b1	.014	.016	.018	0.35	0.40	0.45
D	.094	.098	.102	2.40	2.50	2.60
E	.035	.039	.043	0.90	1.00	1.10
е	.020 BSC		0.50	BSC		
L	.012	.015	.017	0.30	0.38	0.425
N	8		8			
aaa	.003		0.08			
bbb	.004		0.10			

### **Suggested Pad Layout**



DIMENSIONS			
DIM	INCHES	MILLIMETERS	
С	(.034)	(0.875)	
G	.008	0.20	
Р	.020	0.50	
P1	.039	1.00	
Х	.008	0.20	
X1	.016	0.40	
Υ	.027	0.675	
Y1	(.061)	(1.55)	
Z	.061	1.55	

#### NOTES:

CONTROLLING DIMENSIONS ARE IN MILLIMETERS (ANGLES IN DEGREES). THIS LAND PATTERN IS FOR REFERENCE PURPOSES ONLY. CONSULT YOUR MANUFACTURING GROUP TO ENSURE YOUR COMPANY'S MANUFACTURING GUIDELINES ARE MET.

#### **REEL SPECIFICATION**

P/N	PKG	QTY
AZ1045-04F-MS	DFN2510	3000



## **Attention**

- Any and all MSKSEMI Semiconductor products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your MSKSEMI Semiconductor representative nearest you before using any MSKSEMI Semiconductor products described or contained herein in such applications.
- MSKSEMI Semiconductor assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all MSKSEMI Semiconductor products described or contained herein.
- Specifications of any and all MSKSEMI Semiconductor products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer'sproducts or equipment.
- MSKSEMI Semiconductor. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with someprobability. It is possiblethat these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits anderror prevention circuitsfor safedesign, redundant design, and structural design.
- In the event that any or all MSKSEMI Semiconductor products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from theauthorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of MSKSEMI Semiconductor.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. MSKSEMI Semiconductor believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. Whendesigning equipment, referto the "Delivery Specification" for the MSKSEMI Semiconductor productthat you intend to use.

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for ESD Suppressors / TVS Diodes category:

Click to view products by MSKSEMI manufacturer:

Other Similar products are found below:

60KS200C D18V0L1B2LP-7B D5V0F4U5P5-7 DESD5V0U1BB-7 NTE4902 P4KE27CA P6KE11CA P6KE39CA-TP P6KE8.2A

SA110CA SA60CA SA64CA SMBJ12CATR SMBJ33CATR SMBJ8.0A ESD101-B1-02ELS E6327 ESD105-B1-02EL E6327 ESD112-B1
02EL E6327 ESD119B1W01005E6327XTSA1 ESD5V0L1B02VH6327XTSA1 ESD7451N2T5G 19180-510 CPDT-5V0USP-HF

3.0SMCJ33CA-F 3.0SMCJ36A-F HSPC16701B02TP D3V3Q1B2DLP3-7 D55V0M1B2WS-7 DESD5V0U1BL-7B DRTR5V0U4SL-7

SCM1293A-04SO ESD200-B1-CSP0201 E6327 SM12-7 SMLJ45CA-TP CEN955 W/DATA 82350120560 VESD12A1A-HD1-GS08

CPDUR5V0R-HF CPDQC5V0U-HF CPDQC5V0USP-HF CPDQC5V0-HF D1213A-01LP4-7B D1213A-02WL-7 MMAD1108/TR13

5KP100A 5KP15A 5KP18A 5KP48A 5KP90A 5KP90CA